

ABB 5STP27H1800 Control Thyristor datasheet

<http://www.manuallib.com/abb/5stp27h1800-control-thyristor-datasheet.html>

Patented free-floating silicon technology

- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability

ManualLib.com collects and classifies the global product instruction manuals to help users access anytime and anywhere, helping users make better use of products.

<http://www.manuallib.com>

$V_{DRM} = 1800 \text{ V}$
 $I_{T(AV)M} = 3000 \text{ A}$
 $I_{T(RMS)} = 4710 \text{ A}$
 $I_{TSM} = 50.54 \times 1 \text{ A}$
 $V_{T0} = 0.88 \text{ V}$
 $r_T = 0.103 \text{ mW}$

Phase Control Thyristor

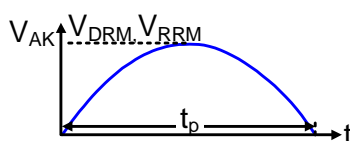
5STP 27H1800

Doc. No. 5SYA1048-03 May 07

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability

Blocking

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	5STP 27H1800	Unit
Max repetitive peak forward and reverse blocking voltage	V_{DRM} , V_{RRM}	$f = 50 \text{ Hz}$, $t_p = 10 \text{ ms}$, $T_{vj} = 5 \dots 125^\circ\text{C}$, Note 1	1800	V
				
Critical rate of rise of commutating voltage	dv/dt_{crit}	Exp. to 1210 V, $T_{vj} = 125^\circ\text{C}$	1000	V/ μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	I_{DRM}	V_{DRM} , $T_{vj} = 125^\circ\text{C}$			200	mA
Reverse leakage current	I_{RRM}	V_{RRM} , $T_{vj} = 125^\circ\text{C}$			200	mA

Note 1: Voltage de-rating factor of 0.11% per °C is applicable for T_{vj} below +5 °C

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		45	50	60	kN
Acceleration	a	Device unclamped			50	m/s^2
Acceleration	a	Device clamped			100	m/s^2

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				0.9	kg
Housing thickness	H	$F_M = 50 \text{ kN}$, $T_a = 25^\circ\text{C}$	25.6		26.3	mm
Surface creepage distance	D_s		36			mm
Air strike distance	D_a		15			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



On-state

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{T(AV)M}$	Half sine wave, $T_c = 70\text{ °C}$			3000	A
RMS on-state current	$I_{T(RMS)}$				4710	A
Peak non-repetitive surge current	I_{TSM}	$t_p = 10\text{ ms}$, $T_{vj} = 125\text{ °C}$, sine wave after surge: $V_D = V_R = 0\text{ V}$			50.54×10^3	A
Limiting load integral	I^2t				12.8×10^6	A^2s
Peak non-repetitive surge current	I_{TSM}	$t_p = 8.3\text{ ms}$, $T_{vj} = 125\text{ °C}$, sine wave after surge: $V_D = V_R = 0\text{ V}$			53.3×10^3	A
Limiting load integral	I^2t				11.8×10^6	A^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 3000\text{ A}$, $T_{vj} = 125\text{ °C}$			1.2	V
Threshold voltage	$V_{(T0)}$	$I_T = 2000\text{ A} - 6000\text{ A}$, $T_{vj} = 125\text{ °C}$			0.88	V
Slope resistance	r_T				0.103	$m\Omega$
Holding current	I_H	$T_{vj} = 25\text{ °C}$			70	mA
		$T_{vj} = 125\text{ °C}$			60	mA
Latching current	I_L	$T_{vj} = 25\text{ °C}$			600	mA
		$T_{vj} = 125\text{ °C}$			200	mA

Switching

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di/dt_{crit}	$T_{vj} = 125\text{ °C}$, $I_T = I_{T(AV)}$, Cont. $f = 50\text{ Hz}$			150	$A/\mu s$
Critical rate of rise of on-state current	di/dt_{crit}	$V_D \leq 1880\text{ V}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu s$ Cont. $f = 1\text{ Hz}$			1000	$A/\mu s$
Circuit-commutated turn-off time	t_q	$T_{vj} = 125\text{ °C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1.5\text{ A}/\mu s$, $V_D \leq 0.67 \cdot V_{DRM}$, $dv_D/dt = 20\text{ V}/\mu s$	400			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse recovery charge	Q_{rr}	$T_{vj} = 125\text{ °C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1.5\text{ A}/\mu s$	400		1000	μAs
Reverse recovery current	I_{RM}		15		40	A
Gate turn-on delay time	t_{gd}	$T_{vj} = 25\text{ °C}$, $V_D = 0.4 \cdot V_{RM}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu s$			3	μs

Triggering

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	V_{FGM}				12	V
Peak forward gate current	I_{FGM}				10	A
Peak reverse gate voltage	V_{RGM}				10	V
Average gate power loss	$P_{G(AV)}$		see Fig. 9			W

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate-trigger voltage	V_{GT}	$T_{vj} = 25\text{ °C}$			2.6	V
Gate-trigger current	I_{GT}	$T_{vj} = 25\text{ °C}$			400	mA
Gate non-trigger voltage	V_{GD}	$V_D = 0.4 \times V_{DRM}$, $T_{vjmax} = 125\text{ °C}$	0.3			V
Gate non-trigger current	I_{GD}	$V_D = 0.4 \times V_{DRM}$, $T_{vjmax} = 125\text{ °C}$	10			mA

Thermal

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T_{vj}				125	°C
Storage temperature range	T_{stg}		-40		140	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double-side cooled $F_m = 45...60\text{ kN}$			10	K/kW
	$R_{th(j-c)A}$	Anode-side cooled $F_m = 45...60\text{ kN}$			20	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled $F_m = 45...60\text{ kN}$			20	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled $F_m = 45...60\text{ kN}$			2	K/kW
	$R_{th(c-h)}$	Single-side cooled $F_m = 45...60\text{ kN}$			4	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
R_i (K/kW)	6.640	2.128	0.755	0.500
τ_i (s)	0.4562	0.0593	0.0055	0.0011

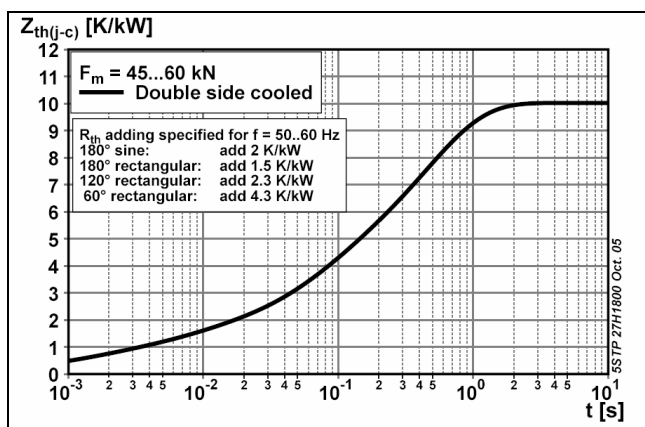


Fig. 1 Transient thermal impedance (junction-to-case) vs. time

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.

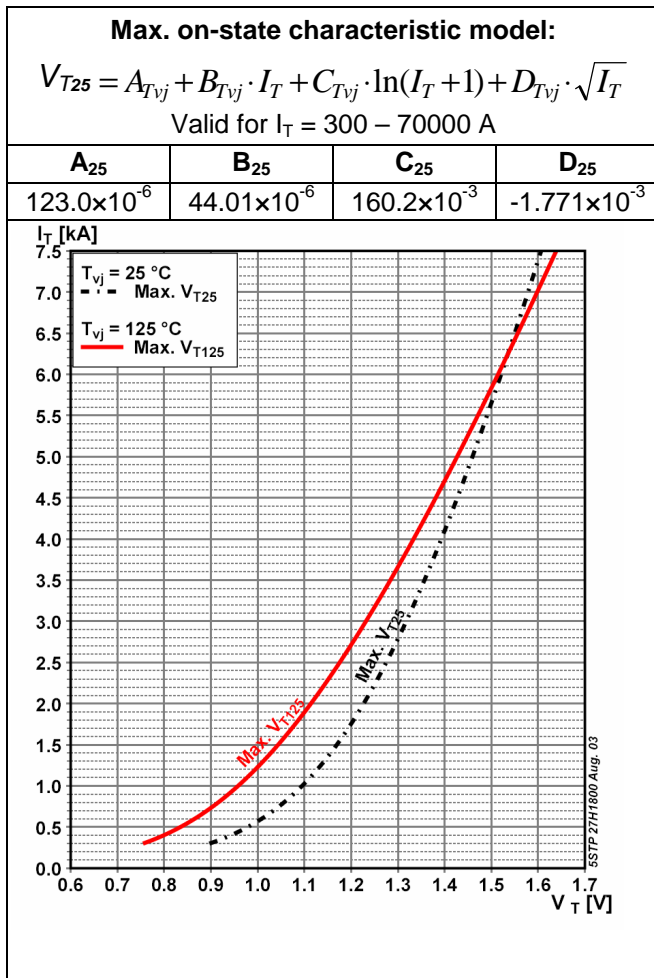


Fig. 2 On-state voltage characteristics

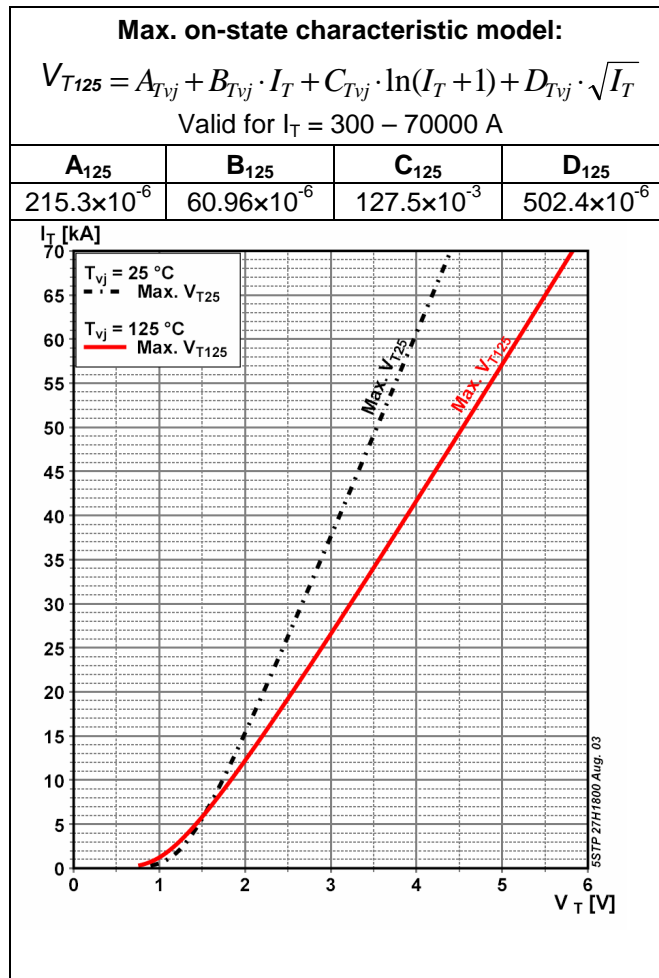


Fig. 3 On-state characteristics, $T_{vj} = 125^\circ\text{C}$, 10ms half sine

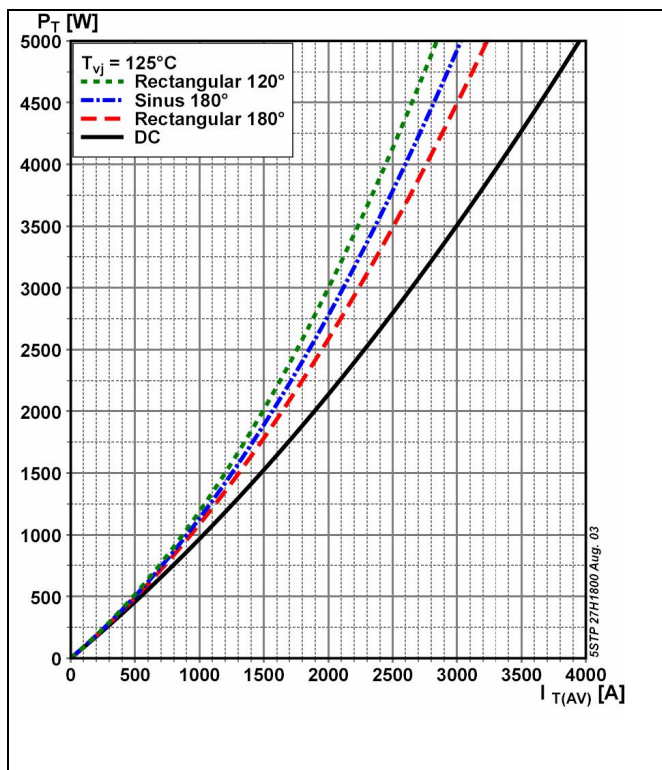


Fig. 4 On-state power dissipation vs. mean on-state current, turn-on losses excluded

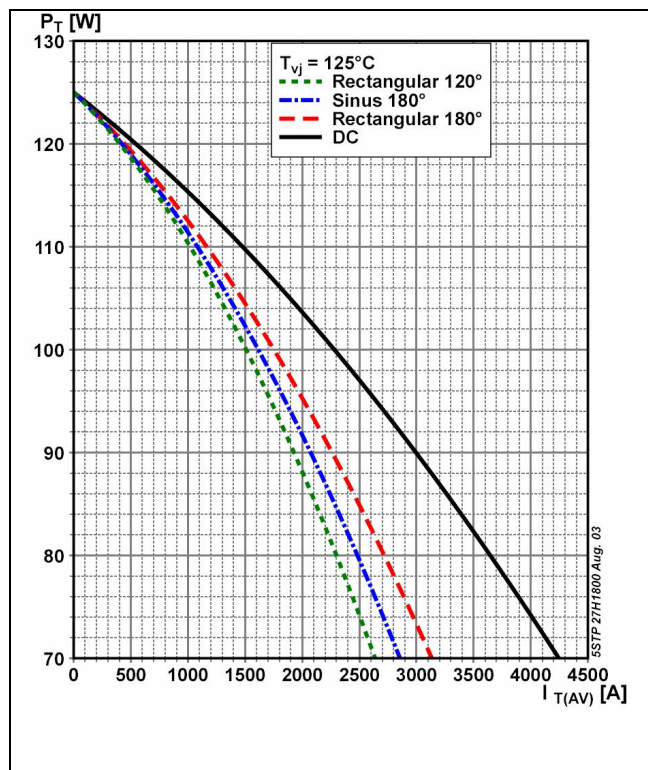


Fig. 5 Max. permissible case temperature vs. mean on-state current, switching losses ignored

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.

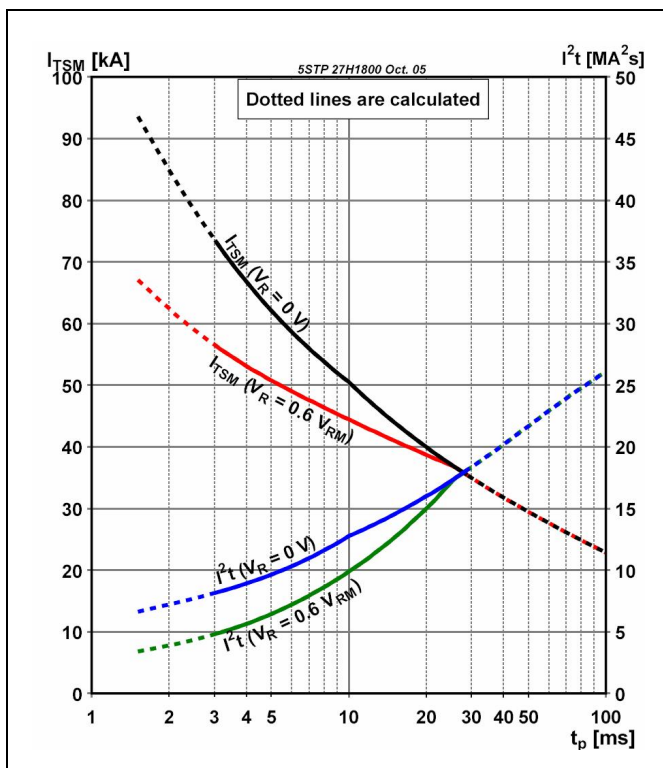


Fig. 6 Surge on-state current vs. pulse length, half-sine wave

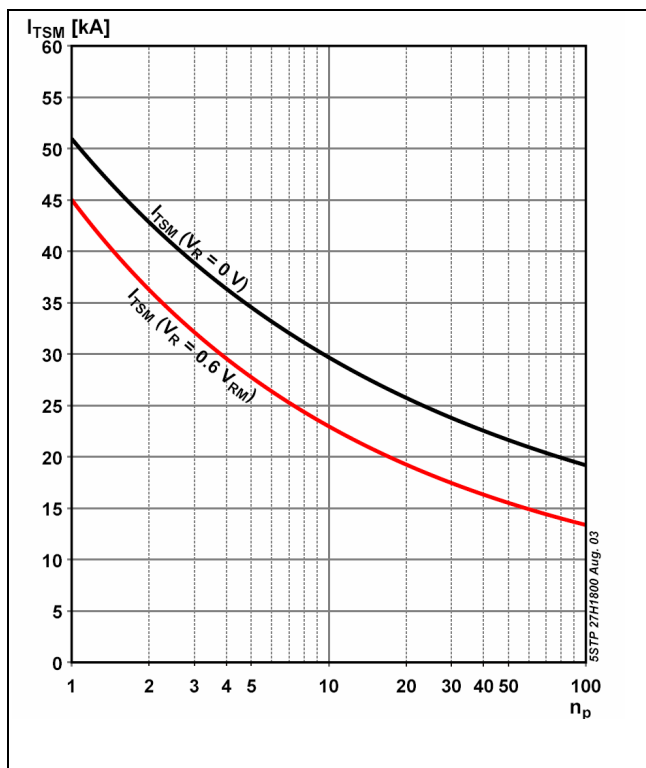


Fig. 7 Surge on-state current vs. number of pulses, half-sine wave, 10 ms, 50Hz

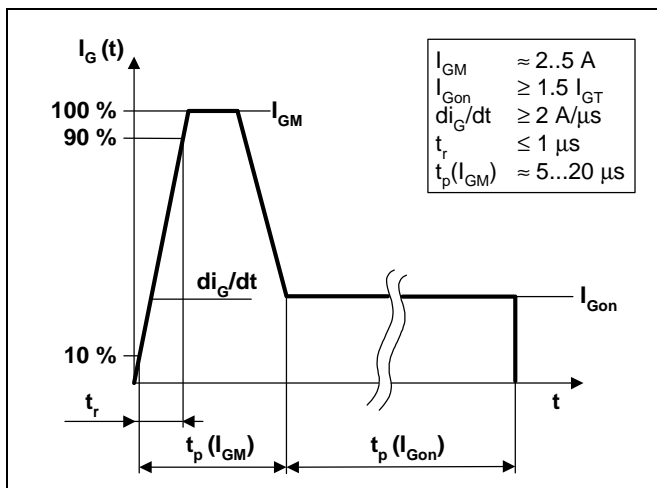


Fig. 8 Recommended gate current waveform

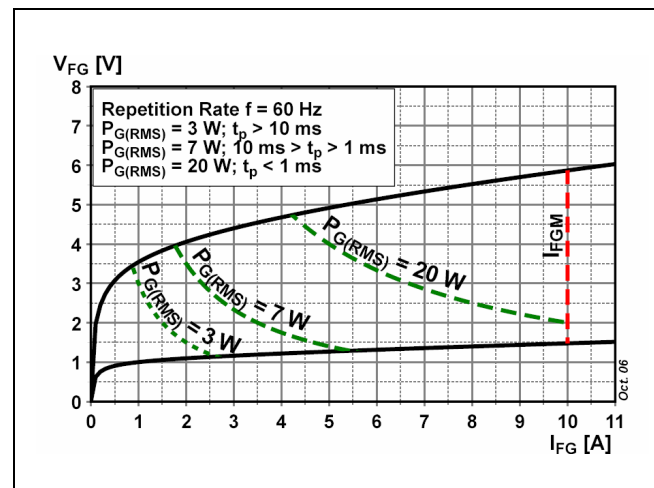


Fig. 9 Max. peak gate power loss

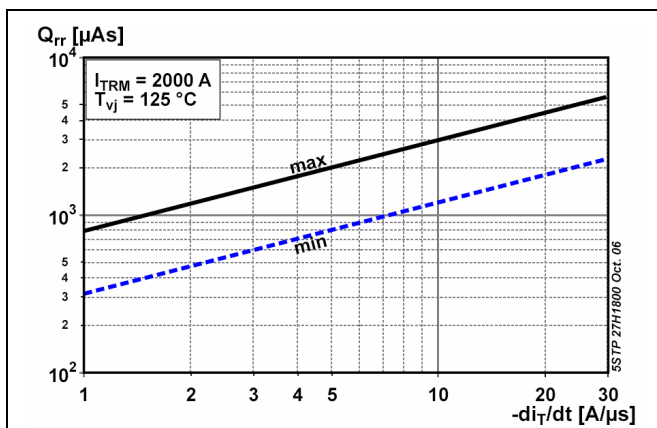


Fig. 10 Reverse recovery charge vs. decay rate of on-state current

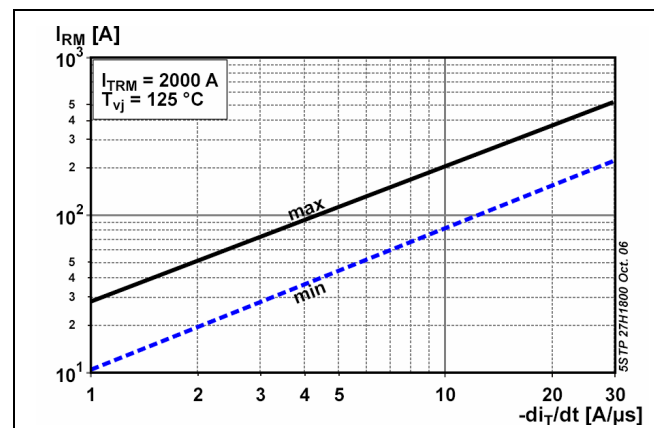


Fig. 11 Peak reverse recovery current vs. decay rate of on-state current

Turn-on and Turn-off losses

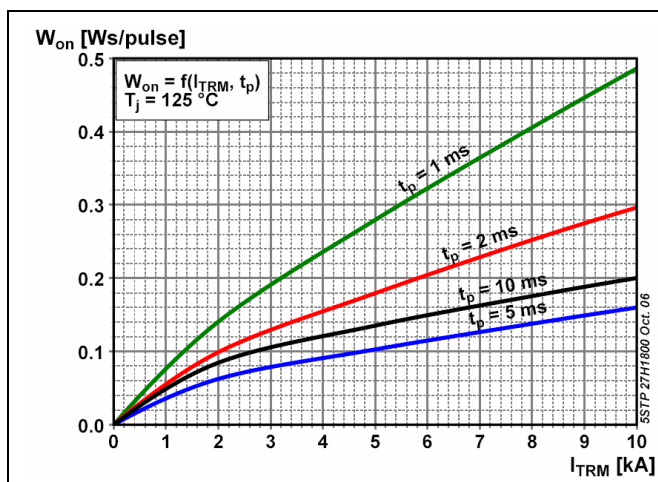


Fig. 12 Turn-on energy, half sinusoidal waves

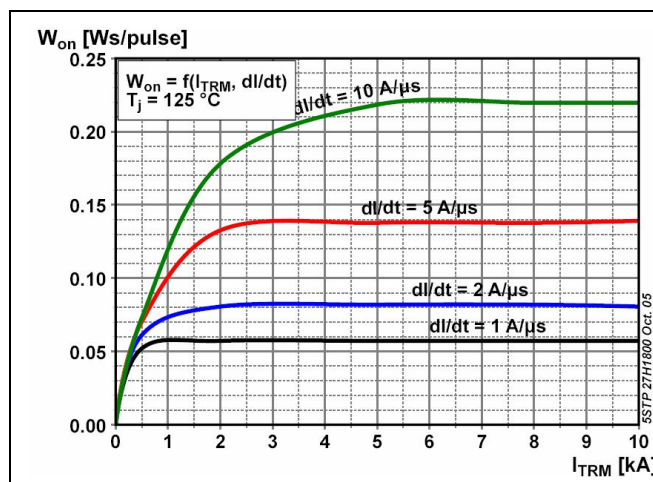


Fig. 13 Turn-on energy, rectangular waves

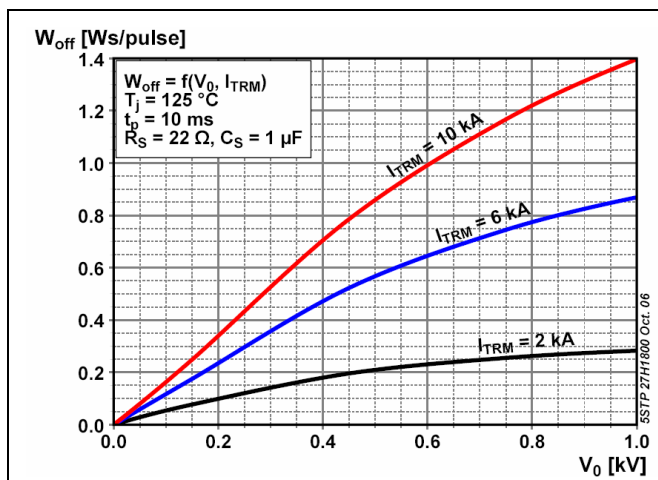


Fig. 14 Turn-off energy, half sinusoidal waves

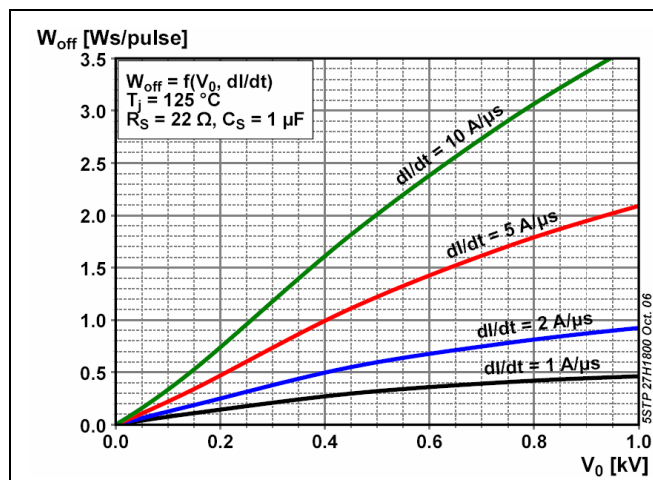


Fig. 15 Turn-off energy, rectangular waves

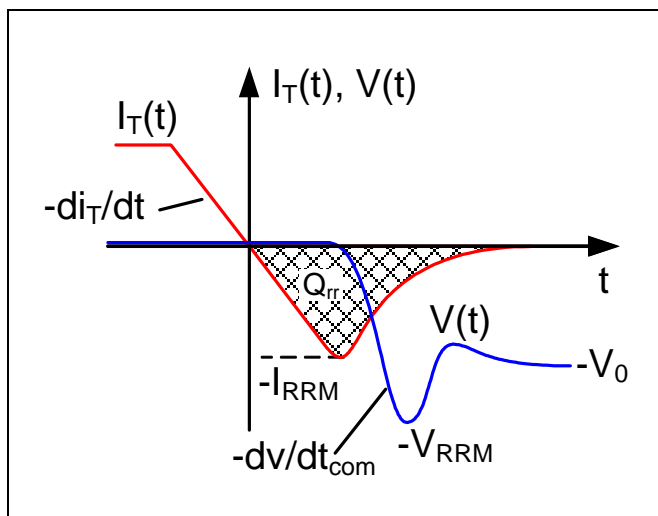


Fig. 16 Current and voltage waveforms at turn-off

Total power loss for repetitive waveforms:

$$P_{TOT} = P_T + W_{on} \cdot f + W_{off} \cdot f$$

where

$$P_T = \frac{1}{T} \int_0^T I_T \cdot V_T(I_T) dt$$

Fig. 17 Relationships for power loss

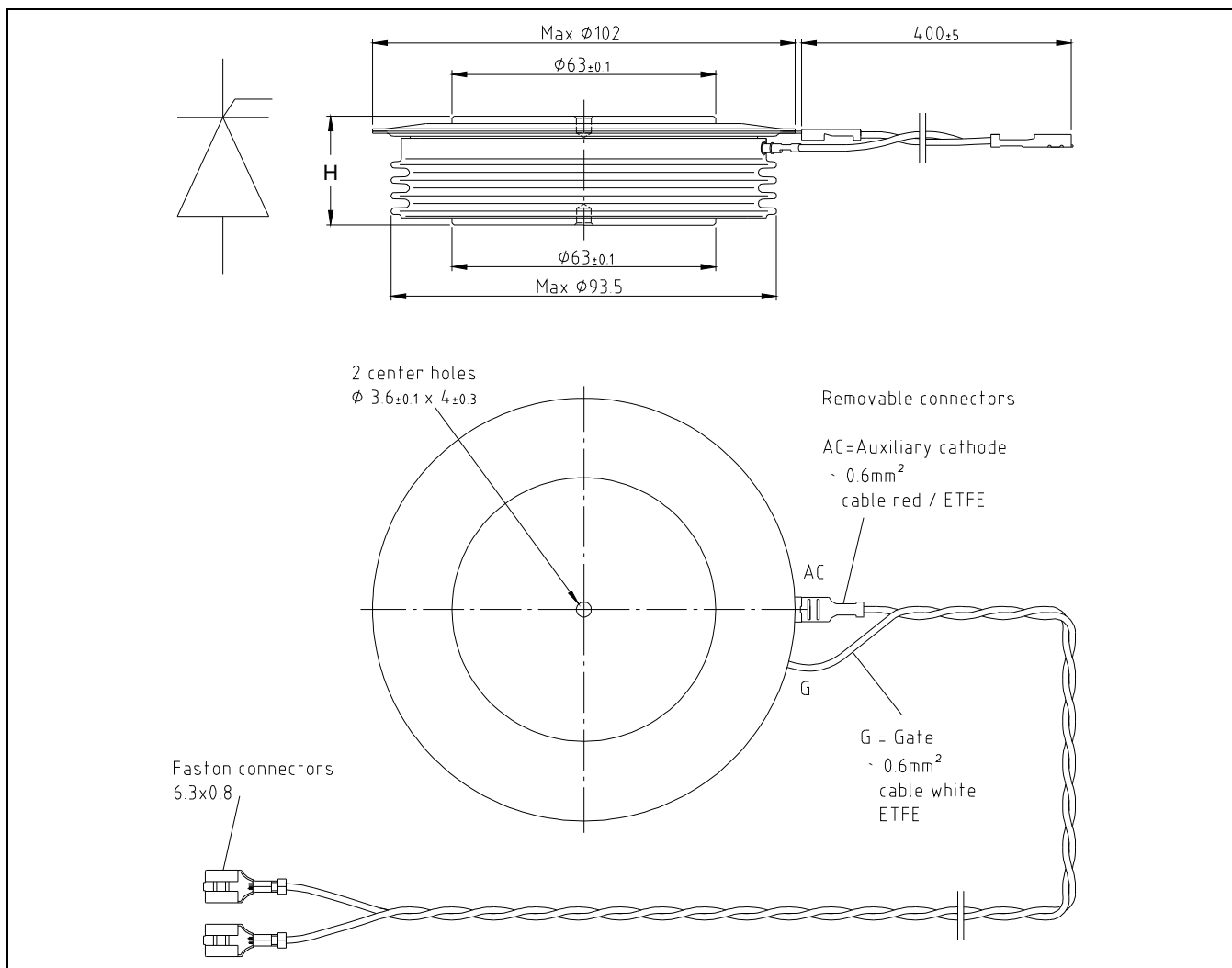


Fig. 18 Device Outline Drawing

Related documents:

5SYA 2020	Design of RC-Snubber for Phase Control Applications
5SYA 2049	Voltage definitions for phase control thyristors and diodes
5SYA 2051	Voltage ratings of high power semiconductors
5SYA 2034	Gate-Drive Recommendations for PCT's
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
5SZK 9104	Specification of environmental class for pressure contact diodes, PCTs and GTO, STORAGE available on request, please contact factory
5SZK 9105	Specification of environmental class for pressure contact diodes, PCTs and GTO, TRANSPORTATION available on request, please contact factory

Please refer to <http://www.abb.com/semiconductors> for current version of documents.

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



ABB Switzerland Ltd
Semiconductors
 Fabrikstrasse 3
 CH-5600 Lenzburg, Switzerland

Doc. No. 5SYA1048-03 May 07

Telephone +41 (0)58 586 1419
 Fax +41 (0)58 586 1306
 Email abbsem@ch.abb.com
 Internet www.abb.com/semiconductors